PM Surface Mount Crystals

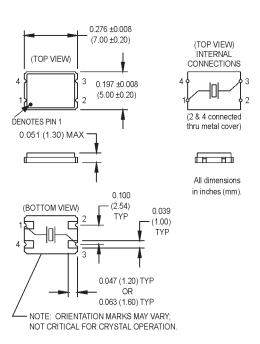
5.0 x 7.0 x 1.3 mm

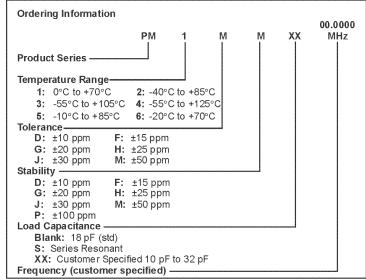






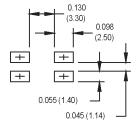






M1007Sxxx - Contact factory for datasheet.

SUGGESTED SOLDER PAD LAYOUT



Available Stabilities vs. Temperature

T	D	F	G	Н	J	М	Р
1	Α	Α	Α	Α	Α	S	Α
2	N	Α	Α	Α	Α	Α	Α
3	N	N	N	N	N	С	С
4	Ν	N	N	N	N	С	С
5	N	Α	Α	Α	Α	Α	Α
6	N	Α	Α	Α	A	Α	Α

A = Available S = Standard

	PARAMETERS	VALUE		
	Frequency Range*	8.000 to 150.000 MHz		
	Tolerance @ +25°C	See Table Above		
	Stability	See Table Above		
	Aging	±5 ppm/yr Max		
ဖွ	Shunt Capacitance	5 pF Max.		
l ö	Load Capacitance	See ordering information		
Specifications	Standard Operating Conditions	See Table Above		
I≝	Equivalent Series Resistance (ESR), Max.			
ĕ	Fundamental (AT-cut)			
	8.0000 to 10.999 MHz	60 Ω		
nta	11.000 to 13.999 MHz	50 Ω		
lei uei	14.000 to 15.999 MHz	40 Ω		
Electrical/Environmental	16.000 to 40.500 MHz	30 Ω		
	Third Overtones (AT-cut)			
	35.000 to 39.999 MHz	100 Ω		
	40.000 to 49.999 MHz	80 Ω		
	50.000 to 90.000 MHz	100 Ω		
lec	Fifth Overtones (AT-cut)			
ш	90.000 to 150.000 MHz	100 Ω		
	Drive Level	100 μW Max., 50 μW Typ., 10 μW Min.		
	Mechanical Shock	MIL-STD-202, Method 213, C		
	Vibration	MIL-STD-202, Method 201 & 204		
	Thermal Cycle	MIL-STD, Method 1010, B		
	Max Soldering Conditions	See solder profile, Figure 1		

^{*} Because this product is based on AT-strip technology, not all frequencies in the range stated are available. Contact the factory for availability of specific frequencies.





